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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





PHOTOCOUPLER PS9303L,PS9303L2

1 Mbps TOTEM POLE OUTPUT TYPE HIGH CMR, IPM DRIVER

HIGH CMR, IPM DRIVER –NEPOC Series– 6-PIN SDIP PHOTOCOUPLER

DESCRIPTION

The PS9303L and PS9303L2 are optical coupled high-speed, totem pole output (active high output type) isolators containing a GaAlAs LED on the input side and a photodiode and a signal processing circuit on the output side on one chip.

The PS9303L and PS9303L2 are specified high CMR and pulse width distortion with operating temperature. It is suitable for IPM drive.

The PS9303L is lead bending type (Gull-wing) for surface mounting.

The PS9303L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

FEATURES

- High common mode transient immunity (CMH, CML = $\pm 15 \text{ kV}/\mu \text{s}$ MIN.)
- Half size of 8-pin DIP
- Pulse width distortion (|tplh tphL| = 350 ns MAX.)
- High-speed (1 Mbps)
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Totem pole output (Active High Output Type)
- <R> Ordering number of tape product: PS9303L-E3, PS9303L2-E3: 2 000 pcs/reel
 - Pb-Free product
- <R> Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
 - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40024069 (Option)

APPLICATIONS

- IPM Driver
- General purpose inverter

PIN CONNECTION (Top View) 6 5 4 1 2 3 1 2 3

TRUTH TABLE

LED	Output
ON	Н
OFF	L

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The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (UNIT: mm)

Lead Bending Type (Gull-wing) For Surface Mount



Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



PHOTOCOUPLER CONSTRUCTION

Parameter	PS9303L	PS9303L2
Air Distance (MIN.)	7 mm	8 mm
Outer Creepage Distance (MIN.)	7 mm	8 mm
Isolation Distance (MIN.)	0.4 mm	0.4 mm

<R> MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS9303L	PS9303L-AX	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS9303L
PS9303L-E3	PS9303L-E3-AX	(Ni/Pd/Au)	Embossed Tape 2 000 pcs/reel	(UL, CSA approved)	
PS9303L2	PS9303L2-AX		20 pcs (Tape 20 pcs cut)		PS9303L2
PS9303L2-E3	PS9303L2-E3-AX		Embossed Tape 2 000 pcs/reel		
PS9303L-V	PS9303L-V-AX		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	PS9303L
PS9303L-V-E3	PS9303L-V-E3-AX		Embossed Tape 2 000 pcs/reel	(VDE0884 Part2)	
PS9303L2-V	PS9303L2-V-AX		20 pcs (Tape 20 pcs cut)	Approved (Option)	PS9303L2
PS9303L2-V-E3	PS9303L2-V-E3-AX		Embossed Tape 2 000 pcs/reel		

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current ^{*1}	lf	20	mA
	Reverse Voltage	VR	5	V
Detecto r	Supply Voltage	Vcc	–0.5 to +25	V
	Output Voltage	Vo	–0.5 to +25	V
	Output Current	lo	25	mA
	Power Dissipation*2	Pc	210	mW
Isolation	Voltage ^{*3}	BV	5 000	Vr.m.s.
Operatino	g Ambient Temperature	Ta	-40 to +100	°C
Storage Temperature		Tstg	-55 to +125	°C

*1 Reduced to 0.33 mA/°C at $T_A = 70°C$ or more.

*2 Reduced to 4.0 mW/°C at TA = 70°C or more.

*3 AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output. Pins 1-3 shorted together, 4-6 shorted together.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc	4.5	15	20	V
Output Voltage	Vo	0		20	V
Input Current (ON)	IF (ON)	6		10	mA
Input Voltage (OFF)	$V_{F}\left(OFF\right)$	0		0.8	V

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	VF	I⊧ = 10 mA, T₄ = 25°C	1.2	1.6	1.9	V
	Reverse Current	IR	$V_{R}=3~V,~T_{A}=25^{\circ}C$			10	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz, T _A = 25°C		30		pF
Detector	High Level Output Voltage	Vон	Vcc = 5 V, lo = −3.5 mA, l⊧ = 10 mA	2.4	3.5		V
			V cc = 20 V, Io = -3.5 mA, Ir = 10 mA	17.4	18.1		
	Low Level Output Voltage ^{*2}	Vol	lo = 3.5 mA, VF = 0 V		0.1	0.35	V
	High Level Supply Current	Іссн	$V_{CC} = 5 V$, $I_F = 10 mA$		1.6	2.7	mA
			Vcc = 20 V, IF = 10 mA		1.8	3	
	Low Level Supply Current	lcc∟	$V_{CC} = 5 V, V_F = 0 V$		2.7	3.7	mA
			$V_{CC} = 20 V, V_F = 0 V$		2.9	4	
	High Level Output Short Circuit Current	Іозн	Vcc = 20 V, Vo = GND, IF = 10 mA	-7	-40		mA
	Low Level Output Short Circuit Current	los∟	$V_{CC} = V_O = 20 \text{ V}, \text{ V}_F = 0 \text{ V}$	7	40		mA
Coupled	Threshold Input Current	IFLH	Vcc = 5 V, Vo > 2.4 V, Io = -3.5 mA		2.4	5	mA
	Isolation Resistance	R⊦o	V⊦o = 500 Vdc, RH = 60%, Ta = 25°C	10 ¹²			Ω
	Isolation Capacitance	Сьо	V = 0 V, f = 1 MHz, T _A = 25°C		0.6		pF
	Propagation Delay Time $(H \rightarrow L)^{*3}$	tph∟	$\label{eq:Vcc} \begin{array}{l} V_{CC} = 20 \text{ V}, C_L = 100 \text{pF}, \\ \\ \text{IF} = 10 \rightarrow 0 \text{mA}, \text{V}_{\text{THHL}} = 1.3 \text{ V} \end{array}$	50	185	550	ns
	Propagation Delay Time $(L \rightarrow H)^{*3}$	tр∟н	$V_{CC} = 20 \text{ V}, \text{ C}_{L} = 100 \text{ pF},$ $I_{F} = 0 \rightarrow 10 \text{ mA}, \text{ V}_{THLH} = 1.3 \text{ V}$	50	240	500	ns
	Pulse Width Distortion (PWD)	tplh-tphl	$V_{CC} = 20 \text{ V}, \text{ CL} = 100 \text{ pF},$ $I_F = 10 \leftrightarrow 0 \text{ mA}$		55	350	ns
	Rise Time (10-90%) ^{*3}	tr	$\label{eq:Vcc} \begin{array}{l} V_{\rm CC} = 20 \ V, \ C_L = 100 \ pF, \\ I_F = 0 \rightarrow 10 \ mA \end{array}$		120		ns
	Fall Time (90-10%) ^{*3}	tr	$\label{eq:Vcc} \begin{array}{l} V_{CC} = 20 \ V, \ C_L = 100 \ pF, \\ I_F = 10 \rightarrow 0 \ mA \end{array}$		90		ns
	Common Mode Transient Immunity at High Level Output ^{*4}	СМн		15			kV/µs
	Common Mode Transient Immunity at Low Level Output ^{*4}	CM∟	$V_{CC} = 5 \text{ V}, \text{T}_{\text{A}} = 25^{\circ}\text{C}, \text{I}_{\text{F}} = 0 \text{mA}, \\ V_{CM} = 1.5 \text{kV}, \text{V}_{\text{O} (\text{MAX})} = 0.35 \text{V}$	15			kV/µs

ELECTRICAL CHARACTERISTICS (TA = -40 to $+100^{\circ}$ C, Vcc = 4.5 to 20 V, unless otherwise specified)

- ***1** Typical values at $T_A = 25^{\circ}C$.
- *2 Because Vo of 2.4 V may be output when the LED current is not input and when output supply of Vcc = 4.5 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- *3 Test circuit for propagation delay time



Remark CL includes probe and stray wiring capacitance.

*4 Test circuit for common mode transient immunity



Remark CL includes probe and stray wiring capacitance.

<R> USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1 μ F is used between V_{cc} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- Pin 2 (which is an NC^{*1} pin) can either be connected directly to the GND pin on the LED side or left open. Unconnected pins should not be used as a bypass for signals or for any other similar purpose because this may degrade the internal noise environment of the device.
 *1 NC: Non-connection (No connection)
- Avoid storage at a high temperature and high humidity.

<R>



TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

Remark The graphs indicate nominal characteristics.

PROPAGATION DELAY TIME

vs. FORWARD CURRENT 100 (su) Vcc = 20 V, 90 CL = 100 pF Pulse Width Distortion | tPLH - tPHL 80 70 60 50 40 30 20 10

PULSE WIDTH DISTORTION

Forward Current IF (mA)

15

20

25

10

0

5

PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

Load Capacitance CL (pF) Remark The graphs indicate nominal characteristics.

300

400

500

200

. TPHL

100

100

0

<R> TAPING SPECIFICATIONS (UNIT: mm)

<R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)

<R> NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- · Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow

Time (s)

(2) Wave soldering

• Flux

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 - Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

Peak temperature (lead part temperature)	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between V_{CC} and GND at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{\text{IDRM}}, P_d < 5 \text{ pC}$	Uiorm Upr	1 130 1 695	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices) U_{Pr} = 1.875 \times U $_{\text{IORM}}$ P $_{\text{d}}$ < 5 pC	Upr	2 119	Vpeak
Highest permissible overvoltage	Utr	8 000	Vpeak
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	СТІ	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		lli a	
Storage temperature range	Tstg	-55 to +125	°C
Operating temperature range	TA	-40 to +100	°C
Isolation resistance, minimum value $V_{IO} = 500 V dc at T_A = 25^{\circ}C$ $V_{IO} = 500 V dc at T_A MAX. at least 100^{\circ}C$	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current IF, Psi = 0) Power (output or total power dissipation)	Tsi Isi Psi	175 400 700	°C mA mW
Vio = 500 V dc at T _A = Tsi	Ris MIN.	10 ⁹	Ω

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M8E0904E

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	 Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.